

Board to Board Connectors Wire to Board Solutions Coaxial Cable Assemblies SIM Card Connectors Micro USB Connectors

2016 Edition















NEW FROM







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PCB Board to Board Connectors

Available in single, dual row, triple and quad row in through hole and surface mount termination, Infratron offer a huge range of board to board PCB header and socket connectors in pin spacing pitches from 1.0mm (.039") through to 5.08mm (.200".) Headers and sockets have a contact range from 2 to 120 and are available in vertical and horizontal orientation.



Connector Pitches





PCB Stacking

PCB Mating Options by Pitch



		Orientation					
Pitch							
	Right Angle	Parallel	Planar				
0.80x1.20mm (.031x.047")		•					
1.00mm (.039")	•	•	•				
1.27mm (.050")	•	•					
1.27x2.54mm (.050x.100")	•	•					
2.00mm (.079")	•	•	•				
2.54mm (.100")	•	•	•				
3.96mm (.156")	•	•					
5.08mm (.200")	•	•					

Parallel Stacking - Elevated Headers



Header - 2 boards





Header & Socket - 3 boards

Header & 2 Sockets - 4 boards



2.54mm (.100") - Through Hole							
Socket BB02 - KH	Header BB02 - TG	Total Board					
Socket Profile	Stacker Height	Spacing					
7.10mm (.280″)	20.00mm (.787″)	27.10mm (1.067")					

1.00mm (.039") - Surface Mount							
Socket BB02 - WA	Header BB02 - TG	Total Board					
Socket Profile	Stacker Height	Spacing					
2.40mm (.094")	10.00mm (.393")	12.40mm (.488″)					



BOARD SPACE

PCB Parallel Stacking

Infratron offer a large range of board to board connectors for parallel PCB mating. The PCB connector stacking guide allows a simple step-by-step system to find the perfect mating connector design solution. You'll be guided to the lowest cost option, helping you design in the perfect balance of a suitable design solution at a great price!

Simply enter the PCB stacking dimension required, then use the narrow your search filter which allows multiple choices for you to compare and contrast solutions. The search displays results 0.5mm either side of your required PCB stack height to offer alternative options where your design is flexible.

Search by:

- Stacking Heights: From 3.0mm (.118") to 60.0mm (2.262").
- Connector Pitch: From 1.00mm (0.039") to 5.08mm (0.200").
- Number of Rows: Single, dual, triple or quad row connectors.
- PCB Mount Type: Surface mount, through-hole or SMT mating with through hole.

Once you've found your perfect height solution, both halves of the connector may then be added to your shopping basket and samples ordered.

If you seek advice on PCB mating speak to your local Infratron sales office, where there is always a connector expert on hand.





Bottom Entry Sockets

Bottom entry sockets (Though Hole and SMT) may be used to:

- Reduce distance between stacked PCB's.
- Allow 'plug up' applications for connection of three PCB's.
- To allow the use of single sided PCB's.

Style of Socket Mating





Check samples in your application before approval.

Stacking Sockets - Through Hole



Pitch	SIL	DIL	Triple	Quad
2.00mm	n/a	BB02-GP	n/a	BB02-GW
2.54mm	BB02-JC	BB02-KD	BB02-LB	n/a



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PCB Right Angle & Planar Mating



Planar (End-to-end) Mating



Pluggable Solutions

Pitch	Number of rows	Header	Socket	Height above PCB	Mount
1.00mm	1	BB02-YN	BB02-WF	1.50mm	Surface Mount
2.00mm	1	BB02-FB	BB02-RK	2.00mm	Through Hole
2.00mm	1	BB02-FK	BB02-RW	2.00mm	Surface Mount
2.00mm	2	BB02-FD	BB02-RL	4.00mm	Through Hole
2.00mm	2	BB02-RH	BB02-RX	4.00mm	Surface Mount
2.00mm	3	BB02-RR	BB02-RQ	6.00mm	Through Hole
2.54mm	1	BB02-HH	BB02-JS	2.50mm	Surface Mount
2.54mm	1	BB02-HA	BB02-JE	2.54mm	Through Hole
2.54mm	1	BB02-TK	BB02-JE	2.54mm	Through Hole
2.54mm	2	BB02-TH	BB02-LE	5.00mm	Surface Mount



U-Shaped Solutions

Pitch	Number of rows	Header	Header Orientation		Mount
1.27mm	1	BB02-5B	U Shaped	2.50mm	Through Hole
2.00mm	1	BB02-1F	U Shaped	2.00mm	Through Hole
2.00mm	1	BB02-2F	U Shaped	2.00mm	Through Hole
2.54mm	2	BB02-2H	U Shaped	5.00mm	Through Hole

 $\mathsf{BB02-1F/2F}$ may be plugged directly into PCB or plugged into vertical sockets.







Plating and Materials

Insulators

Through Hole & SMT Connectors

Insulators are produced in Polyamide 6T (Nylon6T) or LCP as standard, both materials are suitable for with standing high temperature wave and reflow RoHS solder processes.

Pins & Contacts Base Materials

Base material of either Brass or Phosphor bronze depending on product.

Brass

- Lowest cost.
- Good spring properties and strength.
- Reasonably good conductor.

Phosphor Bronze

- Good strength and conductivity.
- Superior elasticity.
- Excellent fatigue resistance.



Base pins and contacts under-plated with nickel.

Finish plating added for improved conductivity, high temperature protection and resistance to corrosion and wear.

Finish plating is available in variants of gold and/or tin.

Gold

- Excellent corrosion resistance and durability.
- Excellent conductivity and low resistance.
- General Rule: Use thicker gold for applications above 100 cycles and less than 1 Amp.

Tin

- Excellent solderability and conductivity.
- Low durability and can form an oxide film.

Finish Plating options.

- Various levels of gold thickness available.
- Options for gold in contact area and tin in solder area (selective plating).
- Gold flash is standard most economical and lowest MOQ.
- Tin Bright or Matt.







Female Socket Contact Styles

Tuning Fork

Two points of contact.

Strengths

- Lower cost
 - Higher retention force

Weaknesses

- Mating pin length limited
- Higher force required
- Top entry only

Leaf Spring

Two points of contact.

Strengths

- No limit on mating pin length
- Less force required
 - Suitable for dual entry
 - Allows lower profile sockets

Weaknesses

- Higher cost
- Low retention force

Boxed and Polarised Products

Shrouded headers and sockets with a 'bump' allow for mating polarisation. Sockets may be plugged into a header in one orientation only.

	Headers			Elevate	d Headers	Sockets			
Pitch	Through Hole		Surface Mount	Through Hole	Surface Mount	Throug	h Hole	Surface Mount	
	Vertical	Horizontal	Vertical	Vertical	Vertical	Vertical	Horizontal	Vertical	
1.27mm	BB02-BE	BB02-BZ	BB02-BY	n/a	BB02-NN	BB02-CU	n/2	BB02-CM	
2.00mm	BB02-FP	BB02-FQ	BB02-FY	BB02-FS	BB02-FW	BB02-RP	n/a	n/2	
2.54mm	BB02-HQ	BB02-BQ	BB02-HR	BB02-HF	n/a	BB02-KW	BB02-KW	n/a	









Custom PCB Connectors

Infratron offer a full custom connector service, from making minor changes on existing products to designing and manufacturing bespoke connectors. With affordable and flexible tooling our experienced engineers will guide you every step of the way, from helping design a solution specific to your needs, onto first draft drawings, then samples, approvals and production. Turnaround time on design to finish can take from a few days to a few weeks depending on complexity.

Examples of special connectors which Infratron created working in partnership with customers include:

Pin Headers Custom Lead lengths – Drawings offer selectable lead lengths for mating & PCB terminating pins.		Non standard pin spacing pitch – This example is 2.54mm between pins and 3.5mm between rows, we can offer other variations upon request.
Custom SMT lead lengths – Often selectable on Infratron drawings, if our parts don't fit the PCB footprint you require, contact us.		Bladed mating pins – Allows connection to tab receptacle type connectors but uses a 0.64mm square pin for PCB termination.
Blanked holes on sockets and missing pins on headers – Offers inexpensive connector polarisation. Header and socket may only be mated together in the orientation. Useful in limited space applications where shrouded header solutions would not fit.	NYLON 97	Alternative insulator materials – This example shows a receptacle normally produced in LCP, being available in Nylon 9T.
PCB Header with pins bent in 3 places – Allows mating on a lower or higher plane		Different insulator colours – For example, Natural.
Kinked Pins on through-hole parts – For PCB retention during soldering. Infratron offer kinked pins upon request.		Press fit custom special – This example was created for a specific custom PCB header design requirement.
Angled pins on headers – Angled specific to your design.		Headers with selectively longer pins – Allows 'make first – break last' contact.
PCB Header and receptacle insulators – Non standard sizes. For a modest tooling fea tricky as sometimes a special contact design	e we can produce non-standa n is required, however often a	rd header insulators, sockets can be more a standard existing contact can be used.



PCB Mating Options Key



PCB Mating Options-

Specification

Current Rating	1 Amp	Toculator Material		Header Pin Size	0.30mm sq. (.011″)	
Operating Temp.	-40°to +105°C		LCP	Disting	Gold Flash or Tin over 30-50µ" Nickel. For more plating options see page 8.	
Contact Material	Brass or Phosphor Bronze	Flammability Rating	UL 94V-0	Plating		

Headers - Single In Line



Туре	Range	Mount	Orientation	Stacking Profile	Ways	Peg
	BB02-YJ	Through Hole	Vertical	1.00mm	2-35	No
Hoodor	BB02-YM	Through Hole	Horizontal	n/a	4-40	No
Header BB02-1 BB02-1	BB02-YN	Surface Mount	Vertical	2.00mm	2-35	No
	BB02-YK	Surface Mount	Horizontal	n/a	2-35	No
Elevated	BB02-YL	Through Hole	Vertical	5.10mm - 20.00mm	2-40	No
Header	BB02-YR	Surface Mount	Vertical	2.50mm - 22.00mm	2-40	No

Sockets - Single In Line

		Но						
	Through Hole		Surfa	ce Mount	t	Surfa	ace Mour	it
	BB02-WD	TTTTTTT	BB02-WE			BB02-WF		and the second
Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length
BB02-WD	Through Hole	Vertical	2.10mm	2-35	Тор	Leaf	No	1.50mm
BB02-WE	Through Hole	Vertical	2.25mm	2-35	Dual	Leaf	No	1.50 - 1.80mm
BB02-WF	Surface Mount	Horizontal	n/a	2-35	Side	Leaf	No	1.50mm



1.00mm (.039") Pitch

PCB Mating Options



Spec						
Current Rating	1 Amp	Teculator Matarial		Header Pin Size	0.30mm sq. (.011″)	
Operating Temp.	-40°to +105°C	Insulator Material	LCP	Disting	Gold Flash or Tin over 30-50µ″ Nickel	
Contact Material	Brass or Phosphor Bronze	Flammability Rating	UL 94V-0	Plating	For more plating options see page 8.	

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Headers & Sockets - Dual In Line

	Vertical Headers						Horizontal Header				Vertical Socket					
т	hrough Ho	le		Surfa	ace Moui	nt	Surface Mount			Su	face Mount					
BB02-YC	4		BB	02-YF	4	Will STATE		YP		вво2-үр		BB02-YP				
BB02-Y0	*		BB()2-ҮН			BB02-YP	* *	- SHERE		BBUZ-WA					
Туре	Range	Moun	t	Orien	tation	Stackir	ng Profile	Ways	Peg	Entry	Contact	Recommended Mating Length				
	BB02-YC	Through I	Hole	Ver	ical	1.5	i0mm	4-80	No							
Header	BB02-YF	Surface M	ount	Ver	tical	1.40mm	- 1.90mm	4-80	No	n/a	n/a	n/a				
	BB02-YP	Surface M	ount	Horiz	ontal	r	n/a	4-30	No							

2.40mm - 20.00mm

2.70mm - 22.00mm

2.25mm

6-80

4-80

4-70

No

No

Option

n/a

Dual

in Size

۱g

n/a

Leaf

Board to Board 1.00mm

Elevated

Header

Socket

PCB Mating Option

n/a

1.50mm - 1.80mm

0.30mm sq. (.011")

Gold Flash or Tin over 30-50µ" Nickel

For more plating options

see page 8.

0.80mm x 1.20mm (.031" x .047") Pitch

Vertical

Vertical

Vertical

Speci	fication			
Current Rating	0.5 Amp	Troulator Material		Header P
Operating Temp.	-40°to +105°C	Insulator Material	LCP	Dist
Contact Material	Phosphor Bronze	Flammability Rating	UL 94V-0	Plati

Full specifications avaiable at Infratron

BB02-YG

BB02-YH

Through Hole

Surface Mount

BB02-WA Surface Mount









1.27mm (.050") Pitch

Spec						
Current Rating	1 Amp	Toculator Material	PA6T	Header Pin Size	0.40mm (.0158") or SIL option 0.46mm (.018")	
Operating Temp.	-40°to +105°C		or LCP	Disting	Gold, Tin or selective over 30-50µ″ Nickel.	
Contact Material Brass or Phosphor Bronze		Flammability Rating	UL 94V-0	Plating	For more plating options see page 8.	

Full specifications avaiable at Infratron

Headers - Single In Line



Туре	Range	Mount	Orientation	Post Size	Stacking Profile	Ways	Peg	
	BB02-NC	Through Hole	Vertical		1.00mm - 2.54mm	2-33	No	Best Price!
	BB02-NB	Through Hole	Horizontal		n/a	2-33	No	
	BB02-NA	Surface Mount	Vertical	0.40mm	1.50mm - 3.00mm	3-33	No	Best Price!
Hoodor	BB02-NS	Surface Mount	Horizontal	Horizontal	n/a	2-20	No	
пеацег	BB02-5B	Through Hole	U-Shaped		n/a	1-50	No	Best Price!
	BB02-BL	Through Hole	Vertical		1.70mm - 3.00mm	2-50	No	Best Price!
	BB02-NH	Through Hole	Horizontal	0.46mm	n/a	2-50	No	
	BB02-BM	Surface Mount	Vertical		3.00mm	3-32	No	
Elevated Header	BB02-NM	Through Hole	Vertical	0.46mm	2.00mm - 36.00mm	2-50	No	

Sockets - Single In Line

	Ve	ŀ	Horizontal			
Thro	ugh Hole	Sur	face Mount	Through Hole		
BB02-NU BB02-CE BB02-CT	mon	BB02-CP BB02-NP				
BB02-CF		BB02-CY	Contraction of the second	BBU2-CI	A REAL PROPERTY.	

Range	Mount	Orientation	Mates with Post Size	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length	
BB02-CT	Through Hole	Vertical/Horizontal		4.30mm	2-40	Тор	Leaf	No	4.00mm	
BB02-CY	Surface Mount	Vertical	0.40mm	2.20mm	2-40	Dual	Leaf	No	1.50mm	
BB02-CP	Surface Mount	Vertical		4.60mm	2-40	Dual	Leaf	No	3.50mm	Best Price!
BB02-NU	Through Hole	Vertical		3.40mm	2-33	Тор	Leaf	No	1.80mm	
BB02-CF	Through Hole	Vertical	0.46mm	4.60mm	2-50	Тор	Tuning Fork	No	2.80mm	Best Price!
BB02-CE	Through Hole	Vertical	0.4011111	8.50mm	2-35	Тор	Tuning Fork	No	4.00mm	
BB02-NP	Surface Mount	Vertical		6.00mm	2-50	Dual	Leaf	No	4.00mm	

Web: www.infratron.de E-Mail: info@infratron.de





1.27mm (.050") Pitch

He	eaders - [Dual In	Line				
	Ver	tical			Horiz	ontal	
Thro	ugh Hole	Surfa	ace Mount	Thro	ough Hole	Surfa	ace Mount
ВВ02-ВС		BB02-BS	A CONTRACT	PR02-PD			
BB02-BE	- HARANA	BB02-BY	-uumu		1 Second	RR02-NE	
RR02-RD	ALL	ВВ02-ВК		BB02-B7		BB02-NL	2 Manual
DDU2-DP	And the second	BB02-NN	and the second	BBU2-B2	- marine		

Туре	Range	Mount	Orientation	Stacking Profile	Ways	Boxed	Peg	
	BB02-BC	Through Hole	Vertical	1.00mm - 3.00mm	4-66	No	No	Best Price!
	BB02-BE	Through Hole	Vertical	1.60mm	4-100	Yes	No	
	BB02-BD	Through Hole	Horizontal	n/a	4-100	No	No	Best Price!
Socket	BB02-BZ	Through Hole	Horizontal	n/a	6-100	Yes	No	
	BB02-BS	Surface Mount	Vertical	1.50mm - 3.50mm	4-100	No	Option	Best Price!
	BB02-BY	Surface Mount	Vertical	1.60mm	10-100	Yes	Option	
	BB02-NE	Surface Mount	Horizontal	n/a	6-80	No	Option	
	BB02-BP	Through Hole	Vertical	2.00mm - 33.00mm	4-100	No	No	
Elevated Socket	BB02-BK	Surface Mount	Vertical	2.50mm - 29.00mm	4-100	No	Option	
Societ	BB02-NN	Surface Mount	Vertical	5.40mm - 15.00mm	10-80	Yes	Option	

Sockets - Dual In Line

	Ver	tical		Horizontal				
Thro	ough Hole	Surfa	ice Mount	Through Hole Surface Mount				
BB02-CN	The second	BB02-CQ BB02-CR BB02-CL	Constanting of the second	BB02-CW		BBAD CV		
BB02-CU (Polarised)	Contraction of the second	BB02-CM (Polarised)		BB02-CZ	ANNIN	BB02-CA	Realize	
					l í	Deserver	and ad	

Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length	
BB02-CN	Through Hole	Vertical	3.40mm - 4.40mm	6-100	Тор	Leaf	No	3.00mm	
BB02-CU	Through Hole	Vertical	4.40mm	8-100	Dual	Leaf	Option	3.00mm	
BB02-CW	Through Hole	Horizontal	n/a	4-100	Side	Leaf	No	3.00mm	Best Price!
BB02-CZ	Through Hole	Horizontal	n/a	6-80	Side	Leaf	No	3.50mm	
BB02-CQ	Surface Mount	Vertical	2.15mm	6-80	Dual	Leaf	Option	1.50mm	
BB02-CR	Surface Mount	Vertical	3.60mm	6-100	Dual	Leaf	Option	3.00mm	
BB02-CL	Surface Mount	Vertical	4.60mm	4-100	Dual	Leaf	Option	4.00mm	Best Price!
BB02-CM	Surface Mount	Vertical	4.60mm	8-100	Dual	Leaf	Option	4.00mm	Best Price!
BB02-CX	Surface Mount	Horizontal	n/a	6-80	Side	Leaf	No	3.50mm	

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1.27mm x 2.54mm (.050" x .100") Pitch

Spec					
Current Rating	1 Amp	Teculator Material	DAGT	Header Pin Size	0.46mm (.018″)
Operating Temp.	-40°to +105°C		PAOT	Disting	Gold, Flash or Tin over 30-50µ" Nickel.
Contact Material	Brass	Flammability Rating	UL 94V-0	Plating	For more plating options see page 8.

Full specifications avaiable at Infratron



Headers - Dual In Line



Vertical

5.10mm - 40.00mm

6-80

No

Sockets - Dual In Line

Through Hole

BB02-DG

Elevated

Header



Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length
BB02-EA	Through Hole	Vertical	4.60mm	6-100	Тор	Tuning Fork	No	2.50mm
BB02-EC	Through Hole	Vertical	8.50mm	6-70	Тор	Tuning Fork	No	4.50mm
BB02-EB	Surface Mount	Vertical	6.00mm	6-80	Dual	Leaf	Option	4.00mm



PCB Mating Options Key



2.00mm (.079") Pitch

PCB Mating Options



Specification

Current Rating	2 Amp			Header Pin Size	0.50mm (.0197″)	
Operating Temp.	-40°to +105°C	Insulator Material	PA6T, PA9T, LCP		Gold, Tin or selective	
Contact Material	Brass or Phosphor Bronze	rass or hor Bronze Flammability Rating UL 94V-0		Plating	OVER 3U-50μ" Nickel. For more plating options see page 8.	

Full specifications avaiable at Infratron

Headers - Single In Line



Туре	Range	Mount	Orientation	Stacking Profile	Ways	Peg
	BB02-FB	Through Hole	Vertical/Horizontal	1.50mm - 2.00mm	2-40	No
Llandau	BB02-FL	Surface Mount	Vertical	3.80mm	2-40	No
пеадег	BB02-FK	Surface Mount	Horizontal	n/a	2-40	No
	BB02-1F	Through Hole	U Shaped	n/a	2-40	No
Elevated	BB02-RM	Through Hole	Vertical	3.00mm - 38.20mm	2-40	No
Header	BB02-RT	Surface Mount	Vertical	4.30mm - 36.00mm	2-40	No

Sockets - Dual In Line







PCB Mating Options

2.00mm (.079") Pitch

	Header	·s - Du	ial In Lin	ne 🛛					
	Vert	ical			Horiz	zontal		U	Shaped
Thro	ugh Hole	h Hole Surface Mount		Through Hole Su		Surf	ace Mount	Through Hole	
BB02-FA BB02-4F* BB02-FD BB02-FG		BB02-FE	Hilling .	BB02-FD					
BB02-FP		BB02-FY	1111 11.	BB02-FG	MANA				
BB02-RN		BB02-FU		BB02-FQ	math	BB02-RH	1988	BB02-2F	
BB02-FS	and the	BB02-FW	and the second	BB02-FZ					

Туре	Range	Mount	Orientation	Stacking Profile	Ways	Boxed	Peg	
	BB02-FA	Through Hole	Vertical	1.00mm	4-80	No	No	
	BB02-4F*	Through Hole	Vertical	1.50mm - 2.00mm	4-60	No	No	
	BB02-FD	Through Hole	Vertical/Horizontal	1.50mm - 2.00mm	4-80	No	No	Best Price!
	BB02-FP	Through Hole	Vertical	1.70mm	6-50	Yes	No	
Hondon	BB02-FG	Through Hole	Vertical/Horizontal	4.00mm	4-80	No	No	
пеасег	BB02-FQ	Through Hole	Horizontal	n/a	6-50	Yes	No	
	BB02-2F	Through Hole	U Shaped	n/a	2-80	No	No	
	BB02-FE	Surface Mount	Vertical	1.80mm - 3.45mm	4-80	No	Option	Best Price!
t	BB02-FY	Surface Mount	Vertical	1.70mm	8-50	Yes	Option	
	BB02-RH	Surface Mount	Horizontal	n/a	4-80	No	Option	
	BB02-RN	Through Hole	Vertical	4.00mm - 38.20mm	4-80	No	No	
	BB02-FS	Through Hole	Vertical	3.70mm - 27.70mm	8-50	Yes	No	
Elevated Header	BB02-FU	Surface Mount	Vertical	4.80mm - 36.00mm	6-80	No	Option	
nedder	BB02-FW	Surface Mount	Vertical	4.30mm - 21.80mm	8-50	Yes	Option	
	BB02-FZ	Through Hole	Horizontal	n/a	4-80	No	No	

* Compatible for surface mount process. Insulator standoffs allow solder paste to sit beneath.

Headers - Triple In Line



Range	Mount	Orientation	Stacking Profile	Ways	Peg
BB02-RR	Through Hole	Vertical/Horizontal	2.00mm	9-120	No

Headers - Quad In Line



Range	Mount	Orientation	Stacking Profile	Ways	Peg
BB02-FM	Through Hole	Vertical/Horizontal	1.50mm	24-120	No

Web: www.infratron.de E-Mail: info@infratron.de





PCB Mating Options

2.00mm (.079") Pitch



Туре	Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length	
	BB02-RP	Through Hole	Vertical	4.00mm	6-80	Тор	Leaf	No	4.00mm	
	BB02-GH	Through Hole	Vertical	4.00mm - 4.30mm	4-80	Тор	Leaf	No	3.00 - 3.80mm	Best Price!
	BB02-GM	Through Hole	Vertical	4.30mm	6-80	Dual	Leaf	No	4.00mm	
	BB02-RL	Through Hole	Vertical/Horizontal	6.35mm	4-80	Тор	Tuning Fork	No	4.00mm	
	BB02-GK	Through Hole	Horizontal	n/a	4-50	Side	Leaf	No	4.00mm	
Carlast	BB02-GL	Through Hole	Horizontal	n/a	6-80	Side	Leaf	No	4.00mm	Best Price!
Socket	BB02-RG	Surface Mount	Vertical	2.20mm	4-80	Dual	Leaf	Option	1.50mm	
	BB02-GZ	Surface Mount	Vertical	2.80mm	6-70	Dual	Leaf	Option	2.00mm	
	BB02-GQ	Surface Mount	Vertical	4.30mm - 4.60mm	6-80	Dual	Leaf	Option	3.00mm	Best Price!
	BB02-RJ	Surface Mount	Vertical	6.35mm	4-80	Тор	Tuning Fork	Option	4.00mm	
	BB02-GY	Surface Mount	Horizontal	n/a	4-50	Side	Leaf	No	4.00mm	
	BB02-RX	Surface Mount	Horizontal	n/a	4-80	Side	Tuning Fork	No	3.20mm	Best Price!
Elevated Socket	BB02-GP	Through Hole	Vertical	8.25mm - 18.55mm	6-80	Тор	Tuning Fork	No	4.00mm	

Vertical Horizontal Through Hole Through Hole BB02-RQ BB02-RQ	5	ockets -	Triple In	Line					
Through Hole Through Hole BB02-RQ BB02-RQ BB02-RQ BB02-RQ			Ve	ertical		Horiz	ontal		
BB02-RQ BB02-RQ BB02-RQ			Throu	ugh Hole	Hole		Through Hole		
			BB02-RQ	Numeron of the second s	BB02-	RQ			
Range Mount Orientation Stacking Ways Entry Contact Peg Mating Length	Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length
BB02-RQ Through Hole Vertical/Horizontal 6.35mm 9-120 Top Tuning Fork No 4.00mm	BB02-RQ	Through Hole	Vertical/Horizont	tal 6.35mm	9-120	Тор	Tuning Fork	No	4.00mm

Sockets - Quad In Line



Туре	Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length
Socket	BB02-GA	Through Hole	Vertical	6.35mm	8-120	Тор	Tuning Fork	No	3.50mm - 4.00mm
Elevated Socket	BB02-GW	Through Hole	Vertical	7.85mm - 14.39mm	16-120	Тор	Tuning Fork	No	3.50mm - 4.00mm



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2.54mm (.100") Pitch

	Head	ders -	Single	In Line	9				
	Ver	tical			Horiz	ontal		U	-Shaped
Throu	gh Hole	Surfa	ce Mount	Thro	ough Hole	Sur	face Mount	Th	ough Hole
BB02-HC BB02-TP* BB02-HA BB02-TC*	HHHHHH	BB02-HY		BB02- HA	- THEFT	BB02-HG		PP02-14	ราป
BB02-HD		ВВ02-ТЈ		ВВ02-ТК	Constant of the second s	вво2-нн	- Hanne	-8802-1H	I IIIII

Туре	Range	Mount	Orientation	Stacking Profile	Ways	Peg	
	BB02-HC	Through Hole	Vertical	1.50mm	2-40	No	
	BB02-TP*	Through Hole	Vertical	1.50mm	2-40	No	
	BB02-HA	Through Hole	Vertical/Horizontal	2.54mm	2-40	No	Best Price!
Hondor	BB02-TC*	Through Hole	Vertical	2.54mm	2-40	No	
Header	BB02-1H	Through Hole	U Shaped	2.54mm	2-40	No	
	BB02-HY	Surface Mount	Vertical	2.91mm - 4.16mm	2-40	Yes	
	BB02-HG	Surface Mount	Horizontal	n/a	2-30	Option	
	BB02-HH	Surface Mount	Horizontal	n/a	2-40	No	Best Price!
	BB02-HD	Through Hole	Vertical	5.08mm - 41.00mm	2-40	No	
Elevated Header	BB02-TJ	Surface Mount	Vertical	6.10mm - 40.00mm	2-40	No	
incutei	BB02-TK	Through Hole	Horizontal	n/a	2-40	No	

 \ast Compatible for surface mount process. Insulator standoffs allow solder paste to sit beneath.

Sockets - Single In Line



Туре	Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length	
	BB02-JT	Through Hole	Vertical	3.50mm	2-40	Тор	Leaf Style	No	2.50mm	
	BB02-JL	Through Hole	Vertical	5.00mm	2-40	Dual	Leaf Style	No	4.50mm	
	BB02-JE	Through Hole	Vertical/Horizontal	5.00mm	2-40	Тор	Leaf Style	No	4.50mm	
	BB02-JF	Through Hole	Vertical	7.10mm	2-40	Тор	Leaf Style	No	4.50mm	
	BB02-JB	Through Hole	Vertical/Horizontal	8.50mm	2-40	Тор	Tuning fork	No	6.00mm	Best Price!
Socket	BB02-JJ	Through Hole	Horizontal	n/a	2-40	Side	Leaf Style	No	4.50mm	
	BB02-JG	Surface Mount	Vertical	7.50mm	2-40	Dual	Leaf Style	No	4.00mm	
	BB02-KR	Surface Mount	Vertical	5.00mm	2-40	Dual	Leaf Style	Yes	4.50mm	Best Price!
	BB02-JR	Surface Mount	Horizontal	n/a	2-40	Side	Leaf Style	No	4.50mm	Best Price!
	BB02-JS	Surface Mount	Horizontal	n/a	2-30	Side	Tuning fork	No	6.00mm	
	BB02-JU	Surface Mount	Horizontal	n/a	2-20	Side	Leaf Style	No	4.50mm	
Elevated Socket	BB02-JC	Through Hole	Vertical	11.05mm - 18.67mm	2-40	Тор	Tuning fork	No	6.00mm	



PCB Mating Options

2.54mm (.100") Pitch

Spe	cification				
Current Rating	3 Amp	Travlatar Matavial		Header Pin Size	0.64mm (.025″)
Operating Temp.	-40°to +105°C		PAGE, OF LCP		Gold or Tin
Contact Material	Brass or Phosphor Bronze	Flammability Rating	UL 94V-0	Plating	For more plating options see page 8.

Full specifications avaiable at Infratron

Headers - Dual In Line



Туре	Range	Mount	Orientation	Stacking Profile	Ways	Boxed	Peg	
	BB02-HJ	Through Hole	Vertical	1.50mm	4-80	No	No	
	BB02-HE	Through Hole	Vertical/Horizontal	2.54mm	4-80	No	No	Best Price!
	BB02-TF	Through Hole	Vertical	2.54mm	4-60	No	No	
	BB02-HQ	Through Hole	Vertical/Horizontal	2.70mm	6-64	Yes	No	
Header	BB02-2H	Through Hole	U Shaped	5.00mm	2-80	No	No	
	BB02-HP	Surface Mount	Vertical	2.60mm - 3.81mm	4-80	No	Option	Best Price!
	BB02-HR	Surface Mount	Vertical	3.80mm	6-64	Yes	No	
	BB02-TD	Surface Mount	Horizontal	n/a	6-60	No	Option	Best Price!
	BB02-TH	Surface Mount	Horizontal	n/a	4-80	No	No	
	BB02-HF	Through Hole	Vertical	5.20mm - 28.70mm	6-64	Yes	No	
Elevated Header	BB02-TG	Through Hole	Vertical	5.10mm - 41.00mm	4-80	No	No	
····	BB02-HU	Surface Mount	Vertical	6.10mm - 41.00mm	6-80	No	Option	

Headers - Triple In Line

	Vertical							Horizontal			
S	Standard - TH			Elevated - TH			Thro	ugh Hole			
вво2-ны		BB	602-TE			BB02-HL					
Туре	Range	Mount		Orio	entation	Sta	cking Profile	Ways	Peg		
Header	BB02-HL	Through H	ole	Vertica	l/Horizontal		2.54mm	9-120	No		
Elevated Header	BB02-TE	Through H	ole	le Vertical 5.10r		mm - 41.00mm	9-120	No			



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PCB Mating Options

2.54mm (.100") Pitch

Sockets - Dual In Line



Туре	Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length	
	BB02-KZ	Through Hole	Vertical	3.50mm	4-80	Тор	Leaf Style	No	2.00mm	
	BB02-KF	Through Hole	Vertical	5.00mm	4-80	Тор	Leaf Style	No	4.50mm	
	BB02-KM	Through Hole	Vertical	5.00mm	4-80	Dual	Leaf Style	No	4.50mm	
	BB02-KG	Through Hole	Vertical	6.80mm	4-60	Тор	Leaf Style	No	6.00mm	
	BB02-KH	Through Hole	Vertical	7.10mm	4-80	Тор	Leaf Style	No	6.00mm	
	BB02-LD	Through Hole	Vertical	7.60mm	4-80	Dual	Leaf Style	No	6.00mm	
	BB02-KK	Through Hole	Vertical	8.50mm	4-80	Тор	Leaf Style	No	6.00mm	
Sockot	BB02-KA	Through Hole	Vertical/Horizontal	8.50mm	4-80	Тор	Tuning fork	No	6.00mm	Best Price!
SUCKEL	BB02-KW	Through Hole	Vertical/Horizontal	8.50mm	6-72	Тор	Tuning fork	No	6.00mm	
	BB02-KT	Through Hole	Vertical	11.00mm	4-80	Тор	Tuning fork	No	4.50mm	
	BB02-JM	Through Hole	Horizontal	n/a	4-80	Side	Leaf Style	No	4.50mm	
	BB02-KY	Surface Mount	Vertical	3.65mm	4-80	Dual	Leaf Style	Option	2.00mm	
	BB02-KS	Surface Mount	Vertical	5.00mm	4-80	Dual	Leaf Style	Option	4.50mm	Best Price!
	BB02-KU	Surface Mount	Vertical	7.50mm	6-80	Dual	Leaf Style	Option	4.50mm	
	BB02-LE	Surface Mount	Horizontal	n/a	4-80	Side	Tuning fork	No	6.00mm	
	BB02-KQ	Surface Mount	Horizontal	n/a	4-80	Side	Leaf Style	No	4.50mm	Best Price!
Elevated Socket	BB02-KD	Through Hole	Vertical	8.50mm - 16.13mm	4-80	Тор	Tuning Fork	No	6.00mm	

Sockets - Triple In Line

	Vertical - Tl	hrough Hole	
St	andard	El	evated
BB02-LA	Name of Street	BB02-LB	

Туре	Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length
Socket	BB02-LA	Through Hole	Vertical	8.50mm	9-120	Тор	Tuning Fork	No	6.00mm
Elevated Socket	BB02-LB	Through Hole	Vertical	11.05mm - 18.67mm	9-120	Тор	Tuning Fork	No	6.00mm

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3.96mm (.156") Pitch

Spe	Specification										
Current Rating	7.9 Amp	Travistar Matavial		Header Pin Size	1.14mm (.0449")						
perating Temp.	-40° to +105°C	Insulator Material	LCP		Matt Tin						
Contact Material	Headers - Brass Sockets - Phosphor Bronze	Flammability Rating	UL 94V-0	Plating	For more plating options see page 8.						

Full specifications avaiable at Infratron

Headers - Single In Line



туре	капде	Mount	Orientation	Stacking Profile	ways	Peg
	BB02-UG	Through Hole	Vertical	3.18mm	2-24	No
Header	BB02-UH	Through Hole	Horizontal	n/a	2-24	No
	BB02-UK	Surface Mount	Vertical	5.73mm	2-24	No
Elevated Header	BB02-UJ	Through Hole	Vertical	6.36mm - 19.80mm	2-24	No

Sockets - S	ingle Iı	n Line		
		Ver	tical	
	Thro	ugh Hole	Surfa	ace Mount
	BB02-US		BB02-UT	

Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length
BB02-US	Through Hole	Vertical	8.89mm	2-24	Тор	3 Points	No	5.00mm
BB02-UT	Surface Mount	Vertical	9.35mm	2-24	Dual	3 Points	No	5.00mm





5.08mm (.200") Pitch

Sp	ecification				
Current Rating	7.9 Amp	Travlatar Matavial		Header Pin Size	1.14mm (.0449″)
Operating Temp.	-40° to +105°C	Insulator Material	LCP		Matt Tin
Contact Material	Headers - Brass Sockets - Phosphor Bronze	Flammability Rating	UL 94V-0	Plating	over 30-50µ° Nickei. For more plating options see page 8.

Full specifications avaiable at Infratron

Headers - Single In Line



2	ockets -							
		Thro	ough Hole	S	urface M	ount		
		BB02-VM		BB02-VI				
Range	Mount	Orientation	Stacking Profile	Ways	Entry	Contact	Peg	Recommended Mating Length
BB02-VM	Through Hole	Vertical	8.89mm	2-24	Тор	3 Points	No	5.00mm
BB02-VN	Surface Mount	Vertical	9.35mm	2-24	Dual	3 Points	No	5.00mm







Planar Mating for LED Lighting Applications

U-Shaped Direct to PCB



U-Shaped with Vertical Sockets

....

Pluggable Solutions



Perfect Height



Many Options Available





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Online Board to Board Narrow Your Search

Filter Options (Showing 176 products) Reset Search											
Pitch Range	Pitch Range Mount Type			Orientation		Number of Rows		Gender		Elevated?	
0.8 x 1.2mm (.031"x.047")	3	Surface mount	70	Right angle	55	Single	75	Socket (Female)	84	No	145
1.00mm (.039")	15	Thru hole	98	Straight	134	Dual	92	Header (Male)	92	Yes	31
1.27mm (.050")	35	Thru hole SMT compatible	4	U shaped	5	Triple	6	Locating Dog2		Delaricod?	
1.27x2.54mm (.050"x.100")	7					Quad	3	Locating Peyr	25	Polariseur	160
2.00mm (.079")	46	Accessory Type						with	30	NO	160
2.54mm (.100")	58	Shunt 1						Without	1/2	Ycs	16
3.96mm (.156")	6										
5.08mm (.200")	6										

↓↓

Infratron online narrow your search facility is fast and easy to use. Filtering by multiple attributes allows you to find your precise requirement in a few clicks. Once you've selected the parts you seek, find drawings, product specifications, 3D models and easily specify mating halves.

Filter Options (Showing 9 products)											
Pitch Range		Mount Type		Orientation		Number of Rows	S	Gender		Elevated?	
0.8 x 1.2mm (.031"x.047")		Surface mount	3	Right angle	2	Single	5	Socket (Female)		No	
		Thru hole		Straight		Dual		Header (Male)	2	Yes	1
1.27mm (.050")	1	Thru hole SMT compatible	0		0.	Triple	1	Locating Dog2		Polaricod?	
1.27x2.54mm (.050"x.100")	2							Locating Peg:		Polariseu:	
2.00mm (.079")	3							With		NO	
2.54mm (.100")								Without	9	Ycs	1
3.96mm (.156")	0										

Pegs for Alignment Critical Applications



Infratron offers a range of SMT board to board connectors with locating pegs. Lead-free alloys are often found to spread less than traditional tin lead solders, pad edges can be left exposed and lower wetting means reduced realignment is possible during reflow. Initial placement accuracy is critical. Pegs allow connectors to be placed perfectly onto the PCB, allowing matching alignment between mating halves.

Connector mating can be critical in many applications, for example in circular LED PCB designs where PCB's are encased in a molded case, misalignment of connectors has implications for final product builds.



Wire to Board Connectors & Cable Assemblies



Suitable for any application where space is at a premium, Infratron's fine-pitch wire-to-board range offers tiny PCB footprints and low profile mounted heights.

Vertical and horizontal PCB headers in single in line orientation are shrouded and polarized to avoid mis-mating. 1.20mm pitch (.047") products allow mating termination in tight spaces allowing ease of use for operators.

A combination of vertical PCB header and cable assembly has a tiny footprint with a mating height of only 3.95mm (.155")*. Where height above the PCB is critical, right angle headers offer a 1.45mm (.057") mated height**.

Rated currents range from are 0.5A (0.8mm pitch) to 1.5A (1.2mm pitch 28AWG). Cable assemblies are available to suit whichever design you choose, see examples on page 28. Cable Sockets and PCB headers are available in a selection of colours for polarisation purposes.

* 0.80mm pitch example ** 1.20mm pitch example

Specifications								
Pitch	0.80mm	1.00mm	1.20mm					
Number of Contacts	2 to 22*	2 to 20	2 to 6					
Current Rating	0.7A AC/DC (AWG 32)	1.0A AC/DC (AWG 28)	1.5A AC/DC (AWG 28) 1.0A AC/DC (AWG 30)					
Voltage Rating	30V AC/DC 50V AC/DC							
Insulator Resistance	100 MΩ minimum							
Dielectric Withstanding	200V AC/minute 500V AC/minute							
Operating Temperature	-25°C to +85°C							
Contact Resistance	20 mΩ maximum							
Insulator Material	Nylon 6T, UL 94V-0							
Header Plating	Matte tin over Nickel	Bright tin over Nickel	Gold Flash over Nickel					
Full specifications avaiable at Infratron			* Header only					



0.80mm (.031") Pitch

PCB Headers & Cable Assemblies Assembly Options **WB06-AA** Wire Vertical AWG32 Unmated Gauge profile of 2.70mm (.106") WH0046 Black, White Grey, Brown Red, Orange (example Cable WB06-AB Colours part Horizontal Yellow, Green number) Blue, Purple Unmated profile of 1.70mm Min. Cable Length 30mm (.067")

Mating Profiles & PCB Layouts



1.00mm (.039") Pitch



Mating Profiles & PCB Layouts





1.20mm (.047") Pitch

PCB Headers & Cable Assemblies Assembly Options Wire AWG28 Gauge AWG30 Horizontal WB06-DA Black, White WH0070 (Unmated Grey, Brown (example profile of Cable Red, Orange part 1.45mm) Colours Yellow, Green number) Blue, Purple Min. Cable 40mm Length

Mating Profiles & PCB Layouts



Online Wire-to-Board Cable Builder

Infratron's wire to board assembly builder allows you to build a custom cable assembly, it's a simple and quick way to request the perfect cable to suit your design.

The builder allows you to specify simple point to point cables and more complex types such as breakout cables. In addition to using Infratron connectors, you may also specify competitor part numbers allowing thousands of variations. The builder allows you to specify connector pin layouts and colour cable identification for each contact.

Choose from options including: Connector type, number of connector contacts, cable length and diameter. Specify extra options - heat shrink, cable marking and jacketing.







Coaxial Cable Assemblies

Infratron offer a wide variety of coaxial cable assemblies, with particular strength in micro coaxial cables for wireless markets, such as GSM, GPS, Wireless LAN (WLAN), Wi-Fi, Zigbee Z-Wave, EnOcean and Bluetooth.



- Extensive range of drawn cable assemblies online.
- Online cable assembly builder.
- Huge range of micro and interface connector options.
- Original Hirose and Murata micro connectors.
- Economical micro connector options from I-Pex.
- Stripped and tinned cables.
- IP68 Nautilus assemblies.
- Test Probe assemblies.





Coaxial Connector Types



○ = Optional O-Ring for thru-panel water resistance

Optional IP67 & IP68 rated for particle and moisture ingress protection (See page 32 - Nautilus)



Coaxial Cable Assembly Information

Stripped & Tinned Cable

Stripped cable with tinned centre conductor and braid, used for solder termination of cable assemblies to a printed circuit board. If the braid length is less than 10.00mm then the braid itself will be tinned, for lengths of 10.00mm or above a piece of tinned flexible copper wire is soldered to the braid.



Frequency Range by Application

Application	Frequency	Popular Interface Connector Types
Bluetooth	2.4 GHz	RP SMA
GPS	1,575 MHz	SMA
GSM (EUR)	900 or 1,800 MHz	SMA, FME
IMS	125 KHz to 50 GHz	Various
UMTS (USA)	1,900 or 2,100 MHz	SMA, FME
WiFi	2.4 GHz	RP TNC
WIMAX	2.4 GHz (mainly)	RP SMA
WLAN	2.4 GHz or 5.8 GHz	RP SMA - Choose appropriate connector at either 3 or 6 GHz.
Zigbee	2.4 GHz	SMA or RP SMA

This is a quick reference guide. Infratron accept no responsibility for incorrect product choice. Check technical specifications of your wireless device to find the correct cable and test samples before volume order.

Connector Orientation

Customers may specify the orientation of right angle connectors within assemblies longer than 40mm. See cable assembly drawings for details



Cable Information

- Wide variety of cable diameters available from ø0.80mm to RG58 and beyond.
- Assemblies are available in lengths to suit your design, from 25mm to 2000mm.
- Special cable types such as Double Shielded or PTFE available request.
- Cable specifications are available online.

Quality Information

- Automatic cable cut & strip machines provide stable & highly efficient production.
- Strict production processes increase stability of quality control.
- All cables 100% electrical conductivity tested.
- Frequency analysis reports (insertion loss and VWSR) available on request.
- 100% production testing available on request.





Nautilus Waterproof Coaxial Cable Assemblies



Nautilus is a range of panel-mounted waterproof coaxial cable assemblies which offer IP67 & IP68 protection from moisture and particle ingress, both mated and unmated.

An internal seal and panel mount O-Ring prevents ingress of water and dust particles through the inner contact or panel cut out. The Nautilus connectors have been stringently tested, for example IPx8 is tested to five meters underwater for a twelve hour period. Applications include remote monitoring, metering, asset tracking and security.

For the other end of the cable assembly, Infratron specialise in micro coax types such as Hirose, Murata and I-Pex. You may also choose from a large range of other standard coaxial connectors.

Find a range of existing IP rated cable assemblies online, or alternatively create your own custom Nautilus cable assembly using Infratron's online coaxial cable assembly builder.

Nautilus Connector Range SMA Straight SMA Straight Bulkhead SMA Straight Bulkhead Jack Jack - Front Mount Bulkhead Jack - RP **NAUTILUS** Ø **BNC Straight** TNC Straight TNC Straight TNC Straight Bulkhead Bulkhead Jack - RP Bulkhead Jack Bulkhead Jack Jack - Front Mount - RP Ø 6

= Reverse Polarity (RP)







Nautlius Waterproof Coaxial Cable Assemblies

The Problem

Moisture and particles may ingress through panel and through the connector centre contact. Customers in many industries seek a fully sealed solution, from splash-proof to being fully immersed in water.



The Nautilus Solution



An O-Ring and inner seal provide protection from ingress from the inner contact and between the connector and bulkhead cut out.

Standards & Testing

Connectors are tested to the following exacting specifications:

- i. IP 6x Dust tight no particle ingress.
- ii. IP x7 Waterproof for 30 minutes up to 1 meter underwater.
- iii. IP x8 Waterproof for 48 hours at 1 meter underwater.
- iv. IP x8 Waterproof for 12 hours at 5 meters underwater.
- v. Pressure test 1 bar = 14.5 PSI (pounds/square inch) for 10 seconds.





Coaxial Test Probes



In line with its strategy for new product development Infratron has launched a new range of low cost co-axial test probe cable assemblies for the inspection of high frequency circuits.

Suitable for testing Hirose MS-156 and Murata MM8030 sub miniature coaxial switch connectors, the new probes offer reliable testing of RF circuits from development through to final production. Mating with Hirose PCB connectors MS156-C (358-0251-2) and MS156 (358-0167-8) the test probe cable assemblies have a mating test cycle durability of 500 operations and 2000 with Murata MM8030-2610.



Online Coaxial Cable Builder



Choose from over 100 existing Cable Assemblies. If you can't find the exact part you seek you may build a custom cable, defining connector type and orientation, cable length, diameter and frequency.



SIM Card Connectors

Infratron offer connectors for SIM card types 2FF Mini, 3FF Micro & 4FF Nano in five connector types.



- **Push-Push**: Push card into place, another push operates a spring which automatically ejects the card.
- Push-Pull: An economical option. Card slots into place and is held by contact force and friction.
- Hinged: Cards are inserted into a hinged cover, the hinge is closed, then locked into place.
- Dual: Accepts two SIM cards, saving space and allowing applications such as dual network.
- **Contact**: Connector with contacts only, no means of holding the card in place.



SIM Card Connectors



Nano SIM Card Connectors



СН03-КВ

Style: Push-Pull Card Type: Nano 4FF Number of contacts: 6 Height: 1.35mm Switch: Without Durability: 1,500 cycles Locating Peg: With Packing: Tape & Reel (of 1500)

and Micro SIM cards.

the wrong way around.

Nano SIM card is also known as 4FF or 4th form factor. The Nano SIM card measures only 8.8mm x 12.3mm ($.346'' \times .484''$) and has a 0.67mm (.026'') thickness. The contact arrangement is identical to Mini

CH03-KB includes card stop functionality which prevents the Nano SIM card being inserted in an incorrect orientation, either upside down or



Communication really is making the world smaller. The ever expanding demand for mobile connectivity combined with the desire for smaller lighter devices has led to a number of developments in both mobile devices and SIM cards themselves.

The latest addition to Infratron's SIM Card Connector family reflects this. CH03-KB, our smallest SIM product, is ideal when space is at a premium, for example hand held devices or wearable mobile products. Our Nano SIM connector is a 6 contact, push-pull connector that measures 12.3mm x 9.8mm with a 1.35mm profile. It's rated for 1,500 card insertion cycles and has an operating temperature range of -40° to +85°C. Accurate PCB placement is achieved via the locating pegs; hold downs offer PCB retention strength.





Micro SIM Card Connectors

Micro SIM card is also known as 3rd form factor (3FF). The card measures only $12mm \times 15mm (.472'' \times .59'')$ and has a 0.76mm (.029'') thickness. Contact arrangement is identical to the standard Mini card. Micro cards use the same size and position of pads as Mini SIM.

The optional solder tab provides extra physical strength and grounding for parts with a metal shell, and an optional card detection switch is designed to detect the presence of a SIM card when inserted.





CH0<u>3-FB</u>

Style: Push-Pull Card Type: Micro 3FF Number of contacts: 6 or 8 Height: 2.40mm Switch: Without Durability: 5,000 cycles Locating peg: Without Packing: Tape & reel (of 900)

CH03-GB

Style: Push-Push Card Type: Micro 3FF Number of contacts: 6 or 8 Height: 1.50mm Switch: With, Normally Closed Durability: 1,500 cycles Locating Peg: Without Packing: Tape & Reel (of 1000)



Push-Push type SIM connectors allow a Micro SIM card to be pushed into place, the 2nd push operates a spring which ejects the card, eliminating the need to extract the tiny card by hand.

Push-Push technology is often used in applications where the end user insets a card from outside the equipment, the connector is normally mounted on the edge of a PCB with the mating face accessible via customer's panel design.





Mini SIM Card Connectors



A Subscriber Identity Module (SIM) Card is available in numerous varieties. Infratron offer connectors for Mini SIM card, also known as 2FF. The SIM card standard reference is ISO/IEC 7810:2003, the card itself measures 25.00mm x 15.00mm (.984" x .59") with a thickness of 0.76mm (.029").

Push-Push Mini SIM Card Connectors



Push-push/push-eject surface mount SIM connectors are either 6 or 8 contact pins. This connector type allows customers to push a SIM card into place, the 2nd push operates a spring which pushes out the card, this removes the need to extract the small and fiddly cards by hand. An optional card detection switch is designed to detect the presence of a SIM card when inserted.

Push-Push is normally used in applications where the end user insets a card from outside the equipment, the connector is normally mounted on the edge of a PCB with the mating face accessible via the customer's panel design. The metal shell provides resistance to heat damage.

CH03-DD-A

Style: Push-Push Card Type: Mini 2FF Number of contacts: 6 or 8 Height: 1.90mm Switch: With, Normally Closed Durability: 5,000 cycles Locating Peg: Optional





CH03-DD-B

Style: Push-Push Card Type: Mini 2FF Number of contacts: 6 or 8 Height: 1.90mm Switch: Without Durability: 5,000 cycles Locating peg: Without



Push-Pull Mini SIM Card Connectors

Push-Pull type works by pushing the SIM card into place. The card is held in place against the plastic frame or metal shell by the force of the contacts, and the card is removed by pulling by hand. The optional solder tab provides extra physical strength and grounding for parts with a metal shell. An optional card detection switch is designed to detect the presence of a card when inserted, and optional locating pegs hold the connector in place during the SMT reflow solder process.

This connector type is an economical option and often used in fit and forget solutions where the card is rarely (or never) plugged and unplugged.





СН03-АА-В

Style: Push-Pull Card Type: Mini 2FF Number of contacts: 6 or 8 Height: 2.40mm

СН03-АА-А

Style: Push-Pull Card Type: Mini 2FF Number of contacts: 6 or 8 Height: 2.40mm Switch: With, Normally Open Durability: 10,000 cycles Locating Peg: Optional Packing: Tubes or Reels

Switch: Without Durability: 10,000 Optional locating peg Packing: Tubes or Reels





CH03-AL

Style: Push-Pull Card Type: Mini 2FF Number of contacts: 6 or 8 Height: 1.80mm Switch: Without

CH03-AJ

Style: Push-Pull Card Type: Mini 2FF Number of contacts: 6 Height: 3.44mm With metal cover Switch: Optional, Normally Open or Normally Closed Durability: 5,000 cycles Locating Peg: Optional Packing: Reels (of 700)

Best Price!

Durability: 5,000 Locating Peg: Without With metal cover Packing: Reels (of 1000)







Hinged Mini SIM Card Connectors



CH03-BE

Style: Hinged Card Type: Mini 2FF Number of contacts: 6 or 8

Switch: With, Normally Open Durability: 10,000 cycles Locating peg: Optional Packing: In Reels





CH03-BH

Style: Hinged Card Type: Mini 2FF Number of contacts: 6 Height: 2.50mm

Switch: With, Normally Open Durability: 5,000 cycles Locating peg: Optional Packing: In Trays or Reels

Hinged SIM connectors allow operators to insert the SIM card into a hinged cover, that cover holds the SIM card in place, the hinge is closed, then locked into place. An optional card detection switch is designed to detect the presence of a SIM card when inserted, and optional locating pegs hold the connector in place during the SMT reflow solder process.

Hinged SIM connectors are often preferred for higher vibration environments, compared to Push-Pull or Push-Push types because of the positive lock characteristics. Polarised molding ensures the cover

Best Price

can only be closed if the card is in the correct position.

CH03-BL

Style: Hinged Card Type: Mini 2FF Number of contacts: 6 or 8 Height: 2.50mm

Switch: Without Durability: 5,000 cycles Locating peg: Optional Packing: Reels (of 800)





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Dual Mini SIM Card Connectors

Dual connectors allow for the plugging of two SIM cards into a single connector. This saves physical space on the PCB and cuts the cost of PCB placement.

In the push-pull configuration, the SIM cards slot into place and are held by friction. The cards are not locked in place and are removed manually. The metal shell provides resistance to heat damage.



CH03-AN

Style: Dual Card Type: Mini 2FF Number of contacts: 8 Height: 3.00mm With metal cover Switch: Without Durability: 5,000 cycles Locating Peg: Without Packing: Reels (of 700)

Contact Mini SIM Card Connectors

A 'contact' SIM Connector describes a connector with open contacts and no integral means of holding SIM card in place. That is handled by customers own design, usually by means of a plastic moulding. An optional locating pegs hold the connector in place during the SMT reflow solder process.

Contact type connectors are suitable for Mini (2ff) and Micro (3ff) and Nano (4ff) SIM cards as there is no change in SIM card contact design between all three GSM card specifications.





CH03-CJ

Style: Contact Card Type: All Number of contacts: 8 Height: 1.30mm, 2.00mm

Switch: Without Durability: 100,000 cycles Locating Peg: Optional Packing Tubes (of 40)





Micro USB 2.0 Connectors

Infratron's range of Micro USB2.0 connectors are available in both B & AB types, mid & bottom mount, 5 contacts a height from 1.59mm above the PCB, up to 10,000 cycles and packed in tape & reel.

- Wide range of PCB receptacles.
 - Variety of mount types.
 - Shell stake options for PCB strength.
 - Plastic locating peg options.
- $30\mu''$ gold contact plating.
 - Meets USB2.0 specification.
 - High durability 10,000 mating cycles.
- On-The-Go (OTG) specification supported by A/B type.











Type B Micro USB 2.0 Connectors

- Small high reliability input/output connector.
- Complies with physical, electrical & environmental requirements of micro USB 2.0 standard.
- Data transfer rate of up to 480 mbps.
- Passive latching prevents unintentional cable release.

- Approx 60% smaller than mini USB.
- Supports Plug-And-Play and hot plugging.
- 30µ" Gold plating in contact area.
 - -25°C ~+85°C Operating temperature.
 - B Type mates with B cable plugs.





UC04-LB

PCB Type: Surface mount PCB Position: Bottom Number of Contacts: 5 Mating Cable Type: B Durability: 10,000 cycles

UC04-LA

PCB Type: Surface mount PCB Position: Bottom Number of Contacts: 5 Mating Cable Type: B Durability: 10,000 cycles Orientation: Horizontal Height: 2.40mm Plastic Locating Peg: Optional Thru hole shell stakes: Without

Orientation: Horizontal Height: 2.35mm Plastic Locating Peg: Without Thru hole shell stakes: With - Outer





UC04-LD

PCB Type: Surface mount PCB Position: Middle - Bottom Number of Contacts: 5 Mating Cable Type: B Durability: 10,000 cycles

UC04-LC

PCB Type: Surface mount PCB Position: Bottom Number of Contacts: 5 Mating Cable Type: B Durability: 10,000 cycles

Orientation: Horizontal Height: 2.35mm Plastic Locating Peg: Optional Thru hole shell stakes: With - Inner

Orientation: Horizontal Height: 1.59mm Plastic Locating Peg: Without Thru hole shell stakes: Without





Type AB Micro USB 2.0 Connectors



- Small high reliability input/output connector.
- Complies with physical, electrical & environmental requirements of micro USB 2.0 standard.
- Data transfer rate of up to 480 mbps.
- Passive latching prevents unintentional cable release.
- Approx 60% smaller than mini USB

- Supports Plug-And-Play and hot plugging.
- \bullet 30 $\mu^{\prime\prime}$ Gold plating in contact area.
- -25°C ~+85°C Operating temperature.
- B Type mates with B cable plugs.
- For use in USB On-The-Go applications.

UC04-NA

PCB Type: Surface mount PCB Position: Bottom Number of Contacts: 5 Mating Cable Type: AB Durability: 10,000 cycles Orientation: Horizontal Height: 2.35mm Plastic Locating Peg: Without Thru hole shell stakes: With





UC04-NC

PCB Type: Surface mount PCB Position: Middle - Bottom Number of Contacts: 5 Mating Cable Type: AB Durability: 10,000 cycles UC04-NB

PCB Type: Surface mount PCB Position: Bottom Number of Contacts: 5 Mating Cable Type: AB Durability: 10,000 cycles Orientation: Horizontal Height: 2.35mm Plastic Locating Peg: Without Thru hole shell stakes: Without

Orientation: Horizontal Height: 1.59mm Plastic Locating Peg: Without Thru hole shell stakes: Without







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Board-to-Board Connectors Wire-to-Board Solutions Coaxial Cables Assemblies Micro USB2.0 Connectors SIM Card Connectors

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